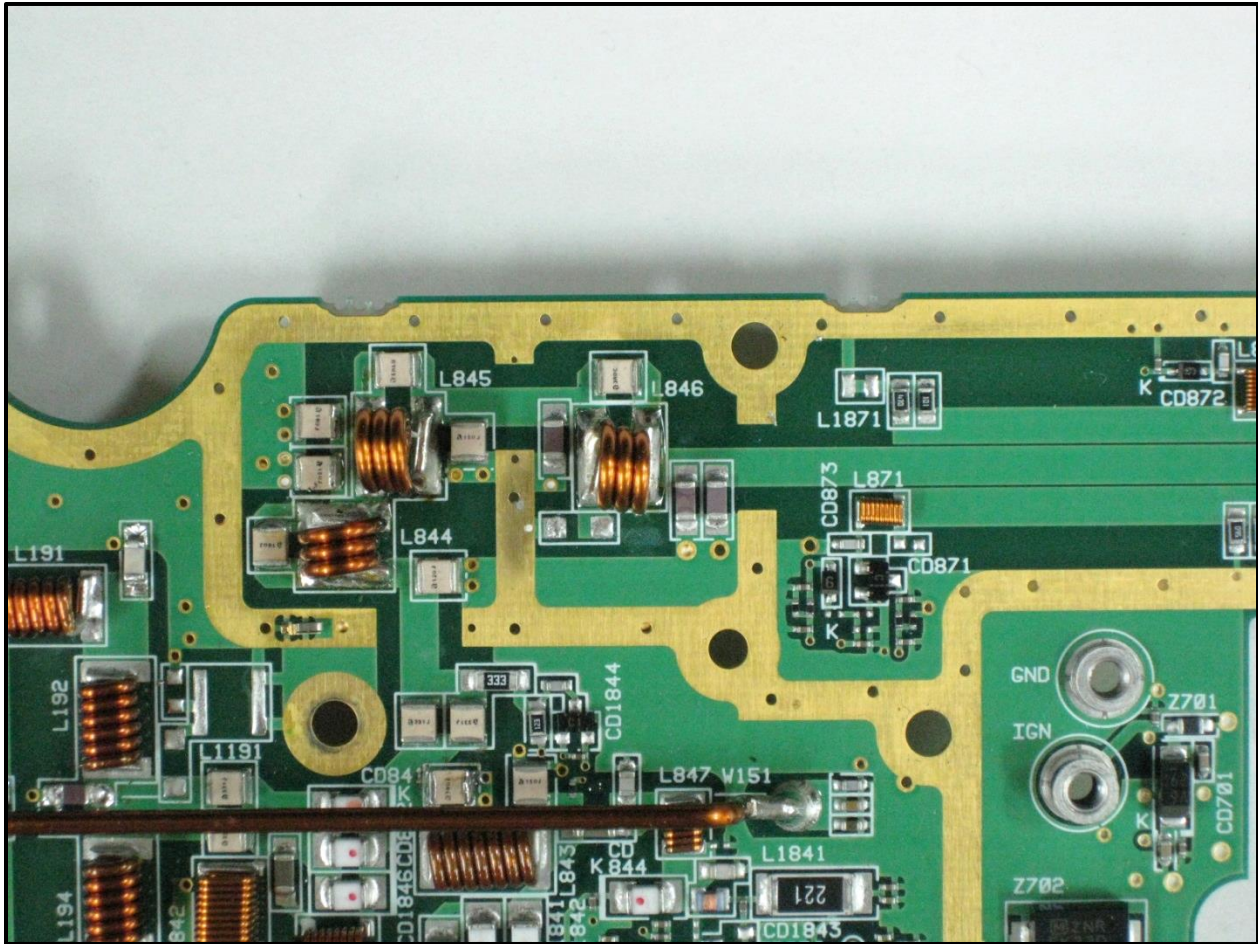
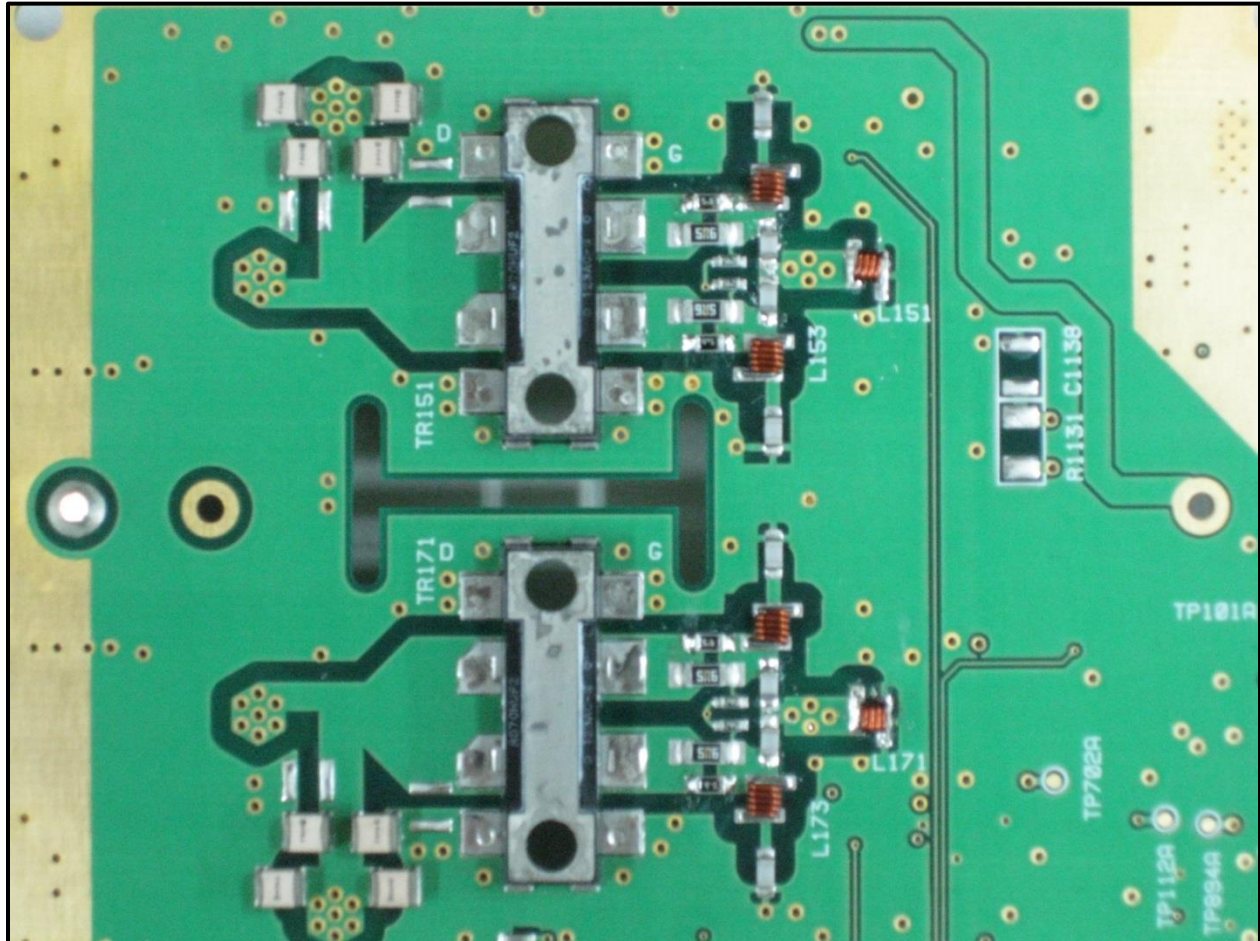


Appendix I: Internal Photographs



Photograph 1: RF Processor Board Component Change LPF



Photograph 2: RF Processor Board Solder Change Final AMP